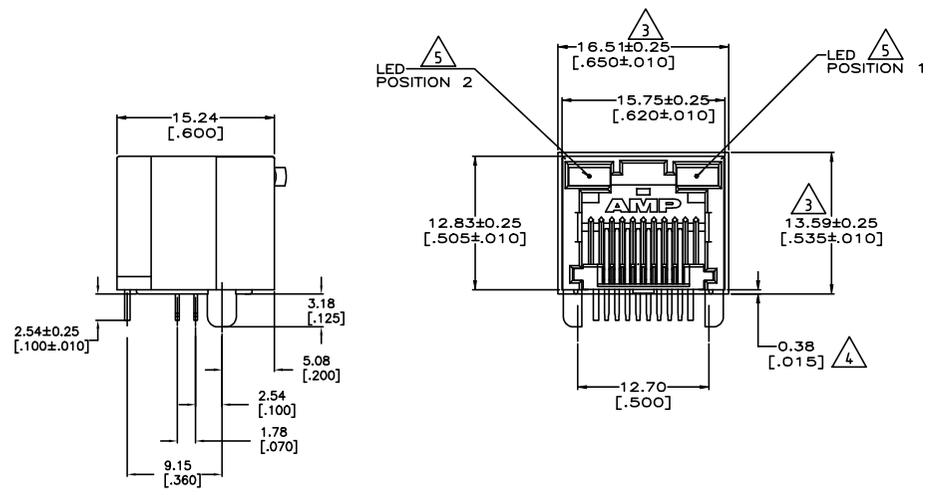
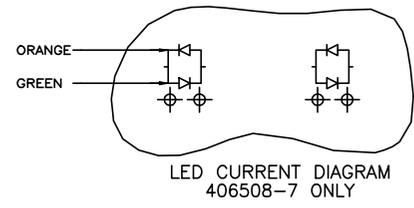
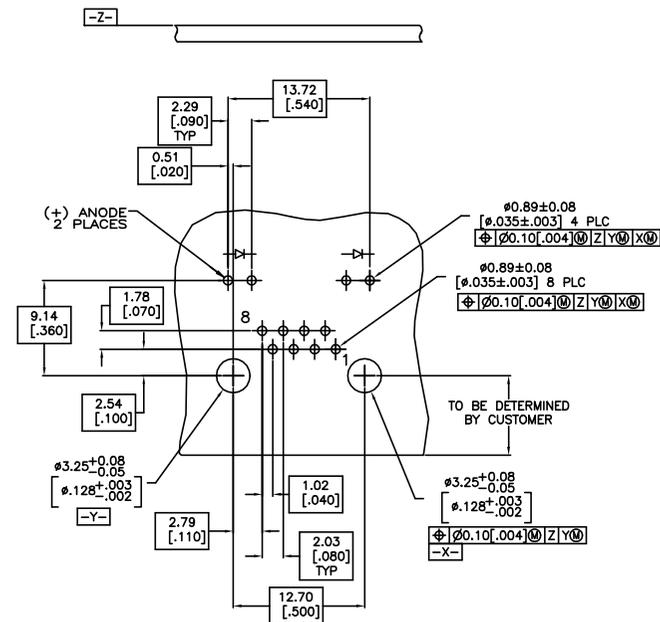


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REVISIONS				
#	DATE	DESCRIPTION	BY	APP'D
C2	ECO-18-014918		21AUG2019	RR SH



- MATERIAL:
HOUSING - HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0.
TERMINALS - 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK BRIGHT TIN LEAD IN SOLDER AREA. 1.27µm [0.00050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [0.00050] MINIMUM THICK NICKEL.
LIGHT EMITTING DIODE (LED) - DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL WIREFRAME LEADS PLATED WITH 8.89µm[0.00350] TIN/COPPER OVER 2.03µm[.000080] SILVER OVER 1.02µm[.000040] NICKEL UNDERPLATE OVER 2.03µm[.000080] COPPER UNDERPLATE.
 - JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
△ SUGGESTED CLEARANCE BETWEEN BOTTOM OF CONNECTOR AND BOTTOM PANEL OPENING.
△ SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
6. THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.
△ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT (COMPONENT SIDE)

INDICATOR COLOR	POSITION 2	POSITION 1	PART NUMBER
△ OBSOLETE	ORANGE/GREEN	ORANGE/GREEN	406508-7
OBSOLETE	YELLOW	YELLOW	406508-6
OBSOLETE	GREEN	GREEN	406508-5
△ SUPERSEDED	GREEN	YELLOW	406508-4
△ OBSOLETE	YELLOW	-	406508-3
	-	GREEN	406508-2
	YELLOW	GREEN	406508-1

THIS DRAWING IS A CONTROLLED DOCUMENT. DIMENSIONS: mm (INCHES). MATERIAL: SEE NOTE 1. FINISH: SEE NOTE 1. PRODUCT #/REV: 108-1163-4. POPULATION #/REV: 114-2154. CUSTOMER DRAWING: 00779. SCALE: 4:1. SHEET: 1 OF 1. REV: C2.

TE Connectivity
INVERTED MODULAR JACK ASSEMBLY, 1X1, LED, ZERO INSERTION FORCE